

Title (en)  
ELECTRONICS ENCLOSURE MOUNTING

Title (de)  
ELEKTRONIKGEHÄUSEMONTAGE

Title (fr)  
MONTAGE D'ENCEINTE D'ÉLECTRONIQUE

Publication  
**EP 3574251 C0 20240403 (EN)**

Application  
**EP 18709439 A 20180126**

Priority  
• US 201715416951 A 20170126  
• US 2018015442 W 20180126

Abstract (en)  
[origin: US2018206631A1] A system for magnetically securing an electronics enclosure proximate a surface of a separate structure. The system includes a mounting apparatus that has a first surface, a second surface, and an interface structure that is constructed and arranged to allow the mounting apparatus to be secured to the surface of the separate structure, with the first surface of the mounting apparatus closer to the surface of the separate structure than is the second surface of the mounting apparatus. One or more magnets are fixed to one or both of the mounting apparatus and the electronics enclosure such that the one or more magnets are arranged to magnetically couple the electronics enclosure to the mounting apparatus.

IPC 8 full level  
**F16M 11/04** (2006.01); **F16M 11/22** (2006.01); **F16M 13/02** (2006.01); **H05K 5/02** (2006.01)

CPC (source: EP US)  
**A47B 21/04** (2013.01 - US); **A47B 21/06** (2013.01 - US); **F16B 1/00** (2013.01 - US); **F16M 11/04** (2013.01 - EP US);  
**F16M 11/041** (2013.01 - EP US); **F16M 11/22** (2013.01 - EP US); **F16M 13/02** (2013.01 - EP US); **H05K 5/0204** (2013.01 - EP US);  
**H05K 7/14** (2013.01 - US); **A47B 2200/0079** (2013.01 - US); **A47B 2200/008** (2013.01 - US); **F16B 2200/83** (2023.08 - US)

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Participating member state (EPC – UP)  
AT BE BG DE DK EE FI FR IT LT LU LV MT NL PT SE SI

DOCDB simple family (publication)  
**US 10492602 B2 20191203**; **US 2018206631 A1 20180726**; CN 110226066 A 20190910; CN 110226066 B 20211102;  
EP 3574251 A1 20191204; EP 3574251 B1 20240403; EP 3574251 C0 20240403; US 10835033 B2 20201117; US 2020000218 A1 20200102;  
WO 2018140721 A1 20180802

DOCDB simple family (application)  
**US 201715416951 A 20170126**; CN 201880008503 A 20180126; EP 18709439 A 20180126; US 2018015442 W 20180126;  
US 201916566483 A 20190910